

**APT2X101D40J 400V 100A
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DUAL DIE ISOTOP® PACKAGE ULTRAFAST SOFT RECOVERY RECTIFIER DIODE

PRODUCT APPLICATIONS	PRODUCT FEATURES	PRODUCT BENEFITS
<ul style="list-style-type: none"> Anti-Parallel Diode <ul style="list-style-type: none"> -Switchmode Power Supply -Inverters Free Wheeling Diode <ul style="list-style-type: none"> -Motor Controllers -Converters Snubber Diode Uninterruptible Power Supply (UPS) Induction Heating High Speed Rectifiers 	<ul style="list-style-type: none"> Ultrafast Recovery Times Soft Recovery Characteristics Popular SOT-227 Package Low Forward Voltage High Blocking Voltage Low Leakage Current 	<ul style="list-style-type: none"> Low Losses Low Noise Switching Cooler Operation Higher Reliability Systems Increased System Power Density

MAXIMUM RATINGS

All Ratings: $T_C = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Characteristic / Test Conditions	APT2X101_100D40J	UNIT
V_R	Maximum D.C. Reverse Voltage	400	Volts
V_{RRM}	Maximum Peak Repetitive Reverse Voltage		
V_{RWM}	Maximum Working Peak Reverse Voltage		
$I_F(\text{AV})$	Maximum Average Forward Current ($T_C = 112^\circ\text{C}$, Duty Cycle = 0.5)	100	Amps
$I_F(\text{RMS})$	RMS Forward Current (Square wave, 50% duty)	164	
I_{FSM}	Non-Repetitive Forward Surge Current ($T_J = 45^\circ\text{C}$, 8.3ms)	1000	
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to 175	°C

STATIC ELECTRICAL CHARACTERISTICS

Symbol		MIN	TYP	MAX	UNIT
V_F	Forward Voltage	$I_F = 100\text{A}$		1.3	1.5
		$I_F = 200\text{A}$		1.6	Volts
		$I_F = 100\text{A}, T_J = 125^\circ\text{C}$		1.2	
I_{RM}	Maximum Reverse Leakage Current	$V_R = V_R \text{ Rated}$		500	µA
		$V_R = V_R \text{ Rated}, T_J = 125^\circ\text{C}$		1000	
C_T	Junction Capacitance, $V_R = 200\text{V}$		260		pF

DYNAMIC CHARACTERISTICS

APT2X101_100D40J

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
t_{rr}	Reverse Recovery Time $I_F = 1A, di_F/dt = -100A/\mu s, V_R = 30V, T_J = 25^\circ C$		-	37		ns
t_{rr}	Reverse Recovery Time	$I_F = 100A, di_F/dt = -200A/\mu s$ $V_R = 268V, T_C = 25^\circ C$	-	50		
Q_{rr}	Reverse Recovery Charge		-	150		nC
I_{RRM}	Maximum Reverse Recovery Current		-	6	7	Amps
t_{rr}	Reverse Recovery Time	$I_F = 100A, di_F/dt = -200A/\mu s$ $V_R = 268V, T_C = 125^\circ C$	-	150		ns
Q_{rr}	Reverse Recovery Charge		-	1050		nC
I_{RRM}	Maximum Reverse Recovery Current		-	13	17	Amps
t_{rr}	Reverse Recovery Time	$I_F = 100A, di_F/dt = -800A/\mu s$ $V_R = 268V, T_C = 125^\circ C$	-	90		ns
Q_{rr}	Reverse Recovery Charge		-	2100		nC
I_{RRM}	Maximum Reverse Recovery Current		-	39		Amps

THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction-to-Case Thermal Resistance			.42	
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance			20	°C/W
W_T	Package Weight		1.03		oz
			29.2		g
Torque	Maximum Terminal & Mounting Torque			10	lb•in
				1.1	N•m

Microsemi Reserves the right to change, without notice, the specifications and information contained herein.

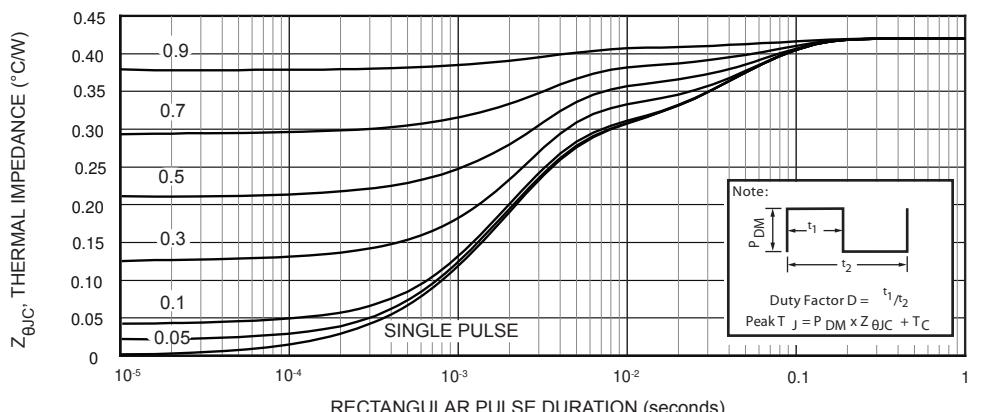
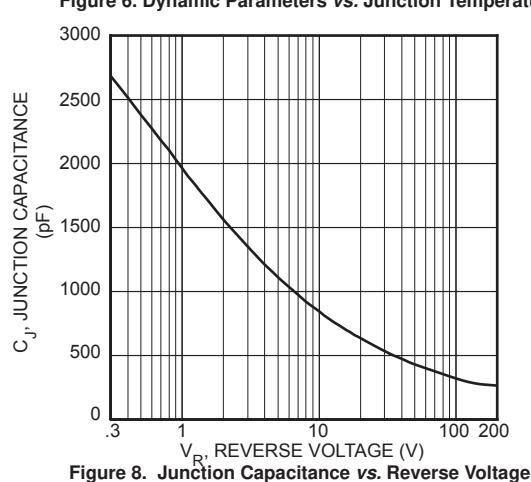
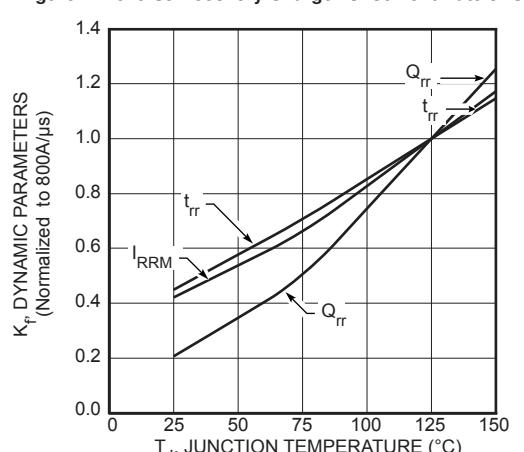
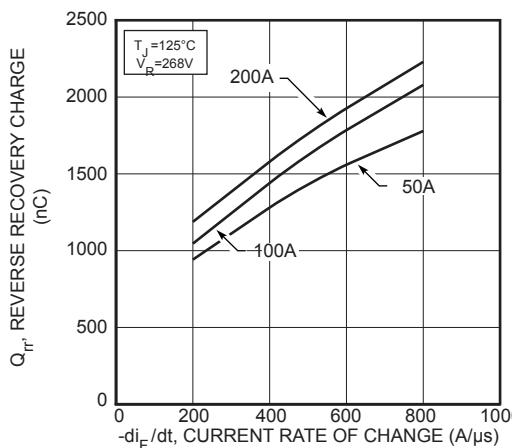
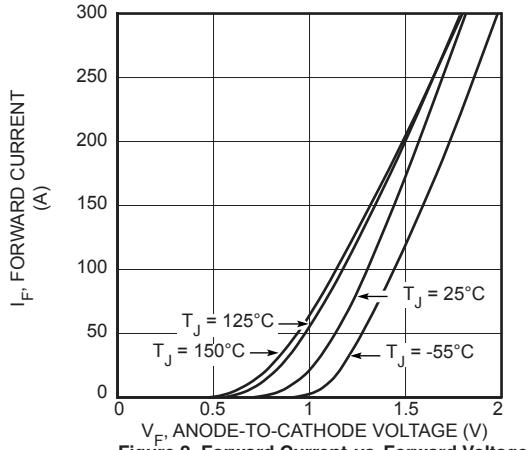
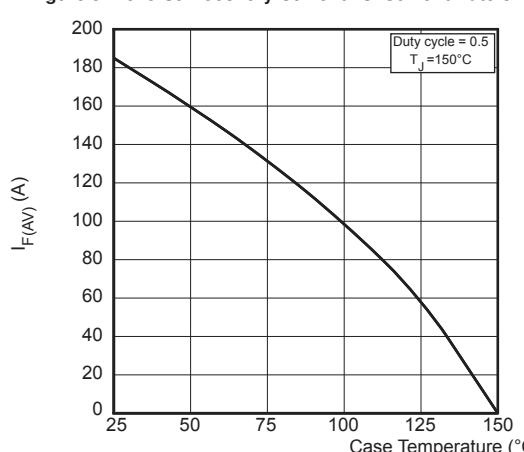
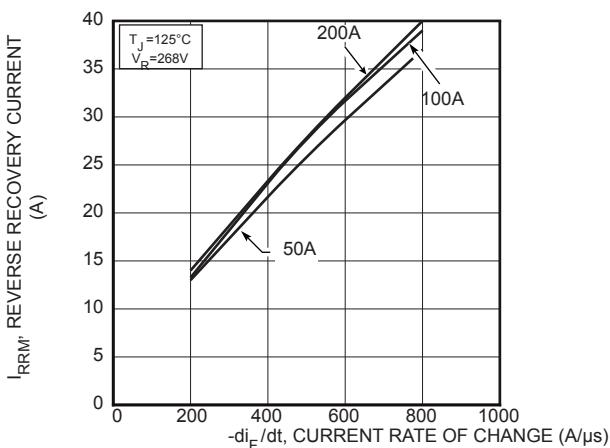
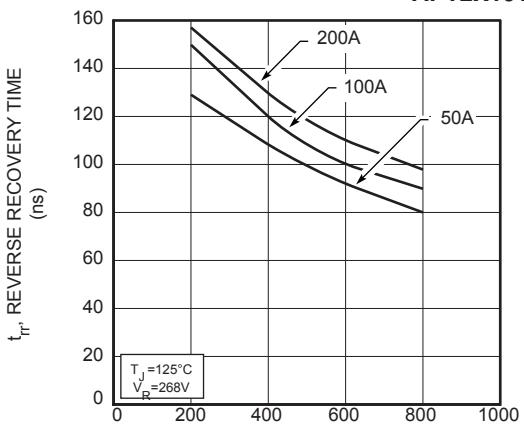


FIGURE 1. MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs. PULSE DURATION

TYPICAL PERFORMANCE CURVES



APT2X101_100D40J



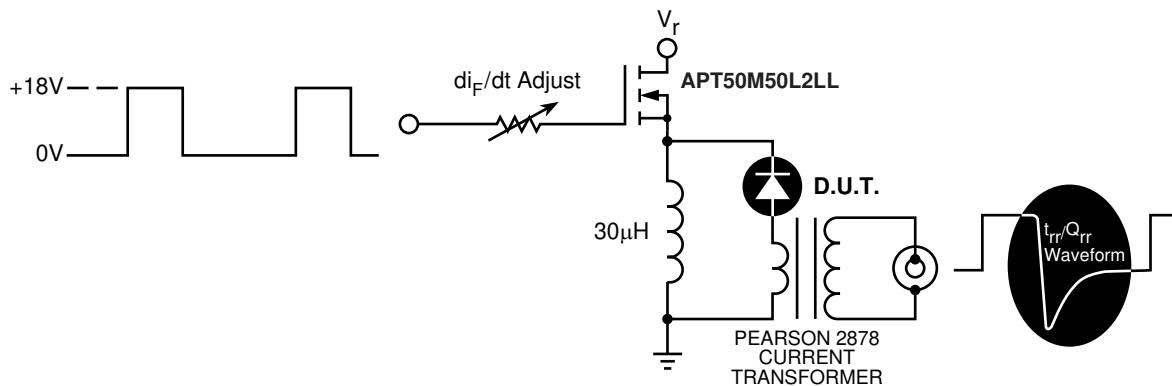


Figure 9. Diode Test Circuit

- ① I_F - Forward Conduction Current
- ② di_F/dt - Rate of Diode Current Change Through Zero Crossing.
- ③ I_{RRM} - Maximum Reverse Recovery Current.
- ④ t_{rr} - Reverse Recovery Time, measured from zero crossing where diode current goes from positive to negative, to the point at which the straight line through I_{RRM} and $0.25 \cdot I_{RRM}$ passes through zero.
- ⑤ Q_{rr} - Area Under the Curve Defined by I_{RRM} and t_{rr} .

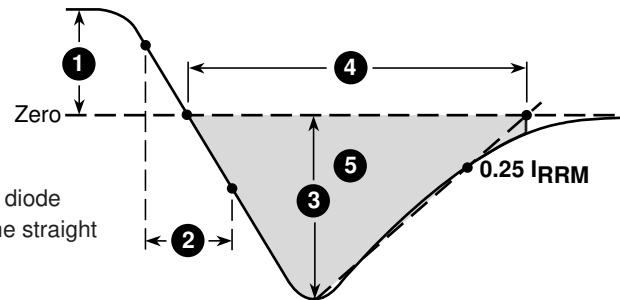


Figure 10. Diode Reverse Recovery Waveform and Definitions

SOT-227 Package Outline

